Board-to-Wire Connectors Pitch 2.5 mm Series H33

Wafer for housing H33H single row, angled



SPECIFICATION:

 $\begin{array}{lll} \mbox{Operating Voltage (Max.):} & 250 \ \mbox{V} \\ \mbox{Operating Current (Nom.):} & 3 \ \mbox{A} \\ \mbox{Operating Temperature:} & -25 \ \mbox{°C} \ \mbox{to } 85 \ \mbox{°C} \\ \mbox{Insulation Resistance (Min.):} & 1000 \ \mbox{M}\Omega \\ \mbox{Contact Resistance (Max.):} & 20 \ \mbox{m}\Omega \\ \mbox{Dielectric Strength:} & 1,000 \ \mbox{Vac} \\ \end{array}$

MATERIAL:

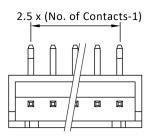
Material (Housing): nylon 66
Material (Terminal): brass, tin plated
Material (Contact Area): brass, tin plated

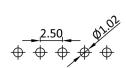
HANDLING:

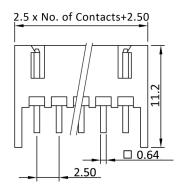
Packaging: bulk

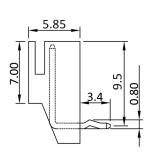
TOLERANCE:

.X: ± 0.25 .XX: ± 0.20









10: 1 x 10

Order Information

Identifier: W33R	No. of Contacts: #
Wafer series H33H pitch 2.5 mm single row angled	2: 1 x 2
	3 : 1 x 3
	# 1 v #